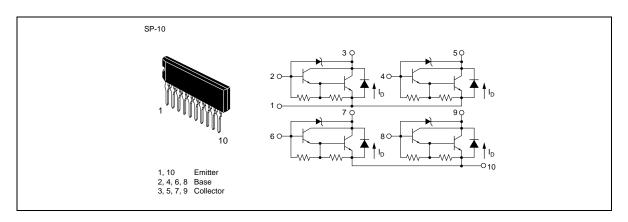
Silicon NPN Epitaxial

# HITACHI

# Application

Low frequency power amplifier

### Outline



#### **Absolute Maximum Ratings** (for each device, $Ta = 25^{\circ}C$ )

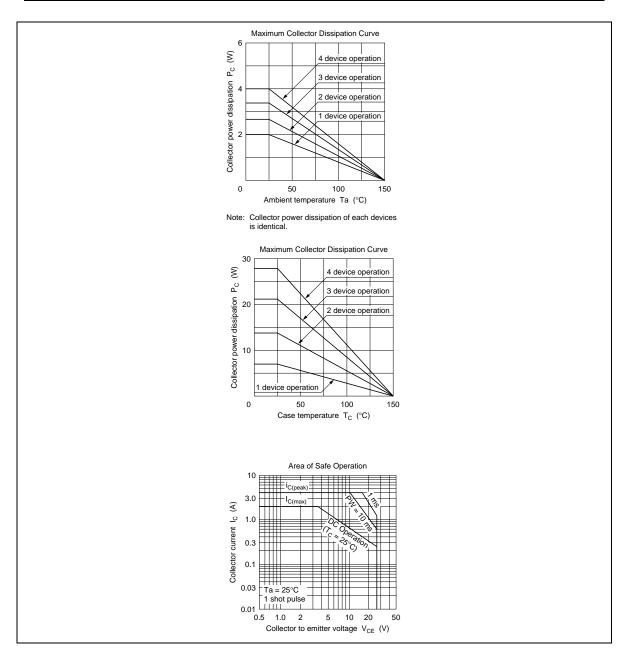
Item	Symbol	Ratings	Unit
Collector to base voltage	V <sub>cbo</sub>	27	V
Collector to emitter voltage	V <sub>ceo</sub>	27	V
Emitter to base voltage	V <sub>ebo</sub>	7	V
Collector current	I <sub>c</sub>	2	А
Collector peak current	I <sub>C(peak)</sub>	4	А
Diode current	I <sub>D</sub>	2	А
Collector power dissipation	<b>P</b> <sub>c</sub> * <sup>1</sup>	4	W
	$P_{c}^{*1}$ (T <sub>c</sub> = 25°C)	28	
Junction temperature	Tj	150	°C
Storage temperature	Tstg	–55 to +150	°C

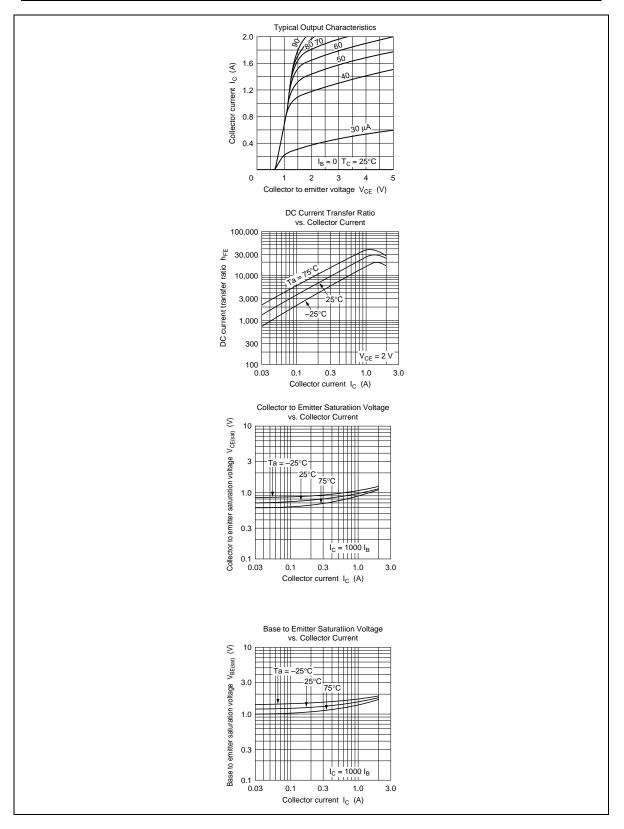
Note: 1. 4 devices operation.

#### **Electrical Characteristics** (for each device, $Ta = 25^{\circ}C$ )

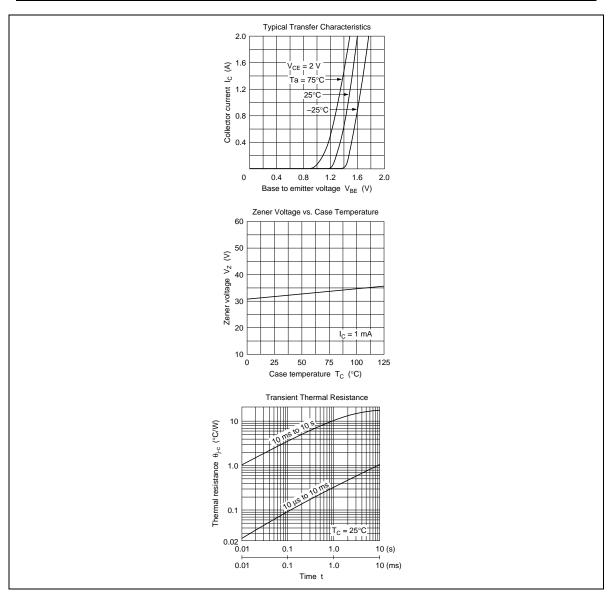
Item	Symbol	Min	Тур	Мах	Unit	Test conditions
Collector to emitter breakdown voltage	$V_{\scriptscriptstyle (BR)CBO}$	27		_	V	$I_{c} = 1 \text{ mA}, I_{e} = 0$
Collector to emitter sustain voltage	$V_{\text{CEO(SUS)}}$	28		36	V	$I_{c}$ = 1 A, L = 20 mH, $R_{BE}$ = $\infty$
Emitter to base breakdown voltage	$V_{\scriptscriptstyle (BR)EBO}$	7	_	—	V	$I_{\rm e} = 5$ mA, $I_{\rm c} = 0$
Collector cutoff current	I <sub>cbo</sub>	—	—	10	μA	$V_{_{CB}} = 20 \text{ V}, \text{ I}_{_{E}} = 0$
	I <sub>ceo</sub>	—	—	10	_	$V_{ce}$ = 20 V, $R_{be}$ = $\infty$
DC current transfer ratio	h <sub>FE</sub>	7000	_	30000		$V_{ce} = 2 V, I_c = 0.5 A$
	h <sub>FE</sub>	2000	_	_		$V_{ce} = 2 V, I_c = 2 A^{*1}$
Collector to emitter saturation voltage	$V_{\scriptscriptstyle CE(sat)}$	_	_	1.5	V	$I_{c} = 2 \text{ A}, I_{B} = 2 \text{ mA}^{*1}$
Base to emitter saturation voltage	$V_{\text{BE(sat)}}$	_	_	2.0	V	$I_{c} = 2 \text{ A}, I_{B} = 2 \text{ mA}^{*1}$
C to E diode forward current	V <sub>D</sub>	_	_	3.5	V	$I_{D} = 2 A$
Noto: 1 Pulso tost						

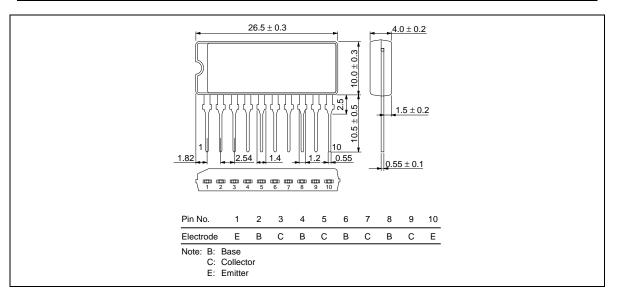
Note: 1. Pulse test.





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